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Customer No.: 31561 Application No.: 10/708,666 Docket No.: 12423-US-PA-X-0P

## REMARKS

## Present Status of the Application

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The Examiner's indication of allowable subject matter in claims 13-17 and 19-22 have been noted with great appreciation, and also that claims 3, 4, 9 and 11 would be allowable if rewritten into independent form and any intervening claims.

The undersigned would like to thank Examiner Douglas W Owens for granting a Telephonic Interview on January 12, 2006, regarding the above-identified application. During the ensuing Telephonic Interview, emphases were made to Examiner Douglas W Owens that element 14 in Figure 8 is a part of the selection gate electrode, rather than a source line. Also, Yaegashi teaches in col. 14, ln. 31 to 39 & Fig. 18 a plug and a wiring layer being formed as the source line and the bit line. Accordingly, element 14 can not be the source lines. Moreover, claim 1 of the instant case teaches "a plurality of source line contacts, through the third dielectric layer, connecting to the source/drain regions that are between each pair of the source lines and electrically connecting to at least one of each pair of the source lines...". In other words, the instant case requires the source line contacts being electrically connected to at least one of each pair of the source lines. It is obvious from Figure 18 of Yaegashi that element 14 can not connected to the source/drain regions. Therefore, even if element 14 could be construed as the source lines as argued by the Examiner, Yaegashi still fails to teach or disclose each element of the claimed invention. Examiner Douglas W Owens had indicated that he now had a better understanding of our arguments, although no agreement was reached during this

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interview. Examiner Douglas Owens further recommended a filing of a response to

better evaluate the prior art reference.

Claims 1-17 and 19-22 are pending. At least for the following reasons,

Applicants respectfully submit claims 1-12 are in proper condition for allowance.

Reconsideration is respectfully requested.

Discussion of the claim rejection under 35 USC 102

The Office Action rejected Claims 1, 2, 5, 6, 8, 10 and 12 and under 35 U.S.C.

102(e) as being anticipated by Yaegashi et al. (US-6.835,987, hereinafter Yaegashi).

Applicants respectfully disagree and respectfully submit, and as emphasized in the

Telephonic Interview with Examiner Douglas W Owens conducted on January 12, 2006,

that Yaegashi cannot anticipate the proposed independent claim 1 because Yaegashi

substantially fails to teach or disclose each and every features of the claimed invention as

claimed in the proposed independent claim 1. More specifically, Yacgashi substantially

fails to teach or disclose a memory device comprising at least [a plurality of source line

contacts, through the third dielectric layer, connecting to the source/drain regions that

are between each pair of the source lines and electrically connecting to at least one of

each pair of the source lines] as required by the proposed independent claim 1. The

advantage of the features recited above is that at least the source lines do not occupy any

extra chip area and therefore the integration of the integrated circuit can be effectively

increased.

In other words, the instant case requires the source line contacts to be electrically

connected to at least one of each pair of the source lines. Instead, Yaegashi teaches in col.

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14, ln. 31 to 39 & Fig. 18 a plug and a wiring layer are formed as the source line and the

bit line. Accordingly, element 14 of Yaegashi can not be the source lines, and it is

obvious from Figure 18 of Yaegashi that element 14 can not connected to the source/drain

regions. Therefore, even if element 14 could be construed as the source lines as argued

by the Examiner, Yaegashi still fails to teach or disclose each element of the claimed

invention. Accordingly, Applicants respectfully submit that Yaegashi cannot possibly

anticipate the proposed independent claim 1 in this regard.

Claims 2, 5, 6, 8, 10 and 12, which directly or indirectly depend from independent

Claim 1, are also patentable over Yaegashi at least because of their dependency from an

allowable base claim.

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For at least the foregoing reasons, Applicants respectfully submit that claims 1, 2, 5,

6, 8, 10 and 12 are in proper condition for allowance. Reconsideration and withdrawal of

above rejections is respectfully requested.

Discussion of the claim rejection under 35 USC 103

The Office Action rejected Claim 7 under 35 U.S.C. 103(a) as being unpatentable

over Yaegashi.

Applicants respectfully disagree and would like to point out that because claim 7,

which depend from the proposed independent claim 1 deemed allowable over Yaegashi

for at least the reasons discussed above, is also patentable over Yaegashi for at least the

same reasons as well. Reconsideration and withdrawal of the above rejections is

respectfully requested.

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## **CONCLUSION**

For at least the foregoing reasons, it is believed that all pending claims 1-17 and 19-22 are in proper condition for allowance. If the Examiner believes that a conference would be of value in expediting the prosecution of this application, he is cordially invited to telephone the undersigned counsel to arrange for such a conference.

Date: (Tan. 18, 2006

Respectfully submitted,

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